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Reconsideration
Searns
6/12/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Fazelpour, S.

Serial No.: 10/025,438

Filed: December 19, 2001

For: Method For Integrating Passives
On-Die Utilizing Under Bump Metal
And Related Structure

Art Unit: 2812

Examiner: Nguyen, Ha T.

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This is in response to the *final rejection*, dated April 3, 2003, in the above-referenced patent application. Reconsideration and allowance of pending claims 1-32 in view of the following remarks are respectfully requested.

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